

企业环境信息公开表（第三季度）

一、基本信息

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	91130300798413970J				
	18			0335-8578888	
	(Printed Circuit Board PCB) (High Density Interconnection HDI) (Flexible Printed Circuit FPC) 3C ISO9001 ISO14001 ISO14064 ISO50001、ISO45001 QC080000				
900-249-08	2256	1.81	0.4955	0.0495	

900-220-08	0	0	0	0
900-014-13	0	0	0	0
900-014-13	0.398	0.398	0	0
900-015-13	0.911	1.12	0	0.209
900-015-13	1.58488	1.38288	0.202	0
900-016-13	60.8805	61.12	27885	3.028
900-016-13	54.2795	51.54	27395	0
900-451-13	27.937	23.54	8441	4.044
266-010-16	0.576	1.654	0	1.078
398-001-16	0.795	1.67	0	0.875
	90.94	92.922	6.9445	8.9265

336-054-17					
336-054-17	59.166	51.945	8.614	1.393	
398-005-22	1642.125	1683.322	14.484	55.681	
398-051-22	295.159	282.062	96.791	83.694	
900-023-29	0.2645	0.339	0	0.0745	
900-052-31	0.8255	0.98	0.247	0.4015	
900-305-34	389.505	389.505	0	0	
772-006-49	212.3675	217.36	2.3005	7.293	
900-039-49	0	0	0	0	
900-041-49	0	0	0.2435	0.2435	
	115.1325	116.17	0.437	1.4745	

900-041-49					
900-041-49	139.692	140.61	0.517	1.435	
900-041-49	125.1785	125.376	2.3635	2.561	
900-041-49	0	0	0.0625	0.0625	
/	10.4715	10	0.664	0.1925	
900-041-49	2.5245	4.223	0	1.6985	
900-045-49	1.8473	1.5667	0.5514	0.2708	
900-045-49	29.7732	33.6894	0.1473	4.0635	

(900-045-49	13.8774	14.092	0.8001	1.0147
MSAP 900-045-49	30.401	32.812	1.4305	3.8415
MSAP 900-045-49	26.711	21.838	9.4345	4.5615
FPC 900-045-49	1.8762	2.562	0.207	0.8928
MSAP 900-045-49	35.1314	0	35.1809	0.0495
FPC 900-045-49	2.5373	2.264	2.3548	2.0815
900-045-49	1.4145	2.462	0	1.0475

261-063-37					
398-005-22	0.798	16.865	0	16.067	
336-054-17	0.283	0	2.709	2.426	
900-016-13	185.2525	178.503	8.0825	1.333	
900-016-13	80.573	87.005	6.7455	13.1775	
336-054-17	116	144	15	43	
336-058-17	319.6	319.6	0	0	
336-062-17	11331.2	11331.2	0	0	
398-004-22	1490.8	1499.8	0	9	
398-007-34	17440.7	17440.7	0	0	
900-041-49	246.948	251.779	2.001	6.832	

398-001-16	3.128	3.128	0	0	
336-057-17	136.8065	132.7575	30.6485	26.5995	
336-057-17	15.856	15.856	0	0	
	34747.91568	34803.52248	263.7375	319.3443	/